TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74AC574P,TC74AC574F,TC74AC574FT

Octal D-Type Flip-Flop with 3-State Output

The TC74AC574 is an advanced high speed CMOS OCTAL FLIP-FLOP fabricated with silicon gate and double-layer metal wiring C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These 8-bit D-type flip-flops are controlled by a clock input (CK) and a output enable input (\overline{OE}).

When the \overline{OE} input is high, the eight outputs are in a high impedance state.

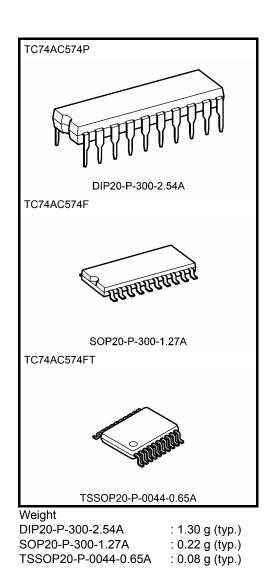
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

- High speed: $f_{max} = 180 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 8 \mu A \text{ (max)}$ at $Ta = 25^{\circ}C$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Symmetrical output impedance: |IOH| = IOL = 24 mA (min)

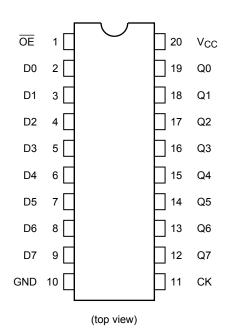
Capability of driving 50 Ω transmission lines

- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 to 5.5 V
- Pin and function compatible with 74F574



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Pin Assignment



IEC Logic Symbol

0E(1) _⊾ CK(11)	EN C1	
D0 (2) D1 (3) D2 (4) D3 (5) D4 (6) D5 (7) D6 (8) D7 (9)	1D ▷ ∇	(19) Q0 (18) Q1 (17) Q2 (16) Q3 (15) Q4 (14) Q5 (13) Q6 (12) Q7

Truth Table

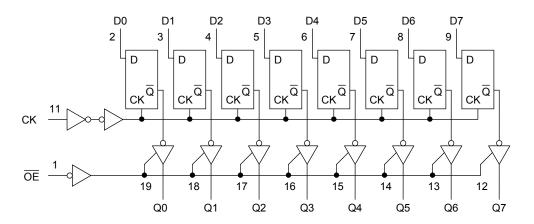
	Inputs	Output			
ŌĒ	СК	D	Q		
Н	Х	Х	Z		
L		Х	Qn		
L		L	L		
L		Н	Н		

X: Don't care

Z: High impedance

Qn: No change

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	IOK	±50	mA
DC output current	IOUT	±50	mA
DC V _{CC} /ground current	ICC	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T _{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65° C. From Ta = 65 to 85° C a derating factor of -10 mW/°C should be applied up to 300 mW.

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	2.0 to 5.5	V	
Input voltage	V _{IN}	0 to V _{CC}	V	
Output voltage	V _{OUT}	0 to V _{CC}	V	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V _{CC} = 3.3 ± 0.3 V)	ns/V	
	u/uv	0 to 20 (V _{CC} = 5 \pm 0.5 V)	115/ V	

Operating Ranges (Note)

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics Symbol			Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit	
Onaracteristics	Gymbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	0.1.1	
					2.0	1.50	_	_	1.50	_	
High-level input voltage	VIH		_		3.0	2.10	_	_	2.10	_	V
				5.5	3.85	_	_	3.85	—		
					2.0	_	_	0.50		0.50	
Low-level input voltage	VIL		_		3.0	_	—	0.90	_	0.90	V
					5.5	—	—	1.65	—	1.65	
					2.0	1.9	2.0	_	1.9	_	
			I _{OH} = −50 µA		3.0	2.9	3.0	—	2.9	—	
High-level output	V _{OH}	V _{IN} = V _{IH} or V _{IL}	N (u. or		4.5	4.4	4.5	—	4.4	—	v
voltage	VОН		I _{OH} = −4 mA		3.0	2.58	_	_	2.48	_	v
			I _{OH} = −24 mA		4.5	3.94	—	—	3.80	—	
			I _{OH} = −75 mA	(Note)	5.5	—	—	—	3.85	—	
					2.0	_	0.0	0.1	_	0.1	
			I _{OL} = 50 μA		3.0	—	0.0	0.1	—	0.1	
Low-level output	V _{OL}	V _{IN} = V _{IH} or V _{IL}			4.5	—	0.0	0.1	—	0.1	V
voltage	VOL		I _{OL} = 12 mA		3.0	_	_	0.36	_	0.44	- V
			I _{OL} = 24 mA		4.5	—	—	0.36	—	0.44	
			I _{OL} = 75 mA	(Note)	5.5		—			1.65	
3-state output off-state current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_	_	±0.5	_	±5.0	μΑ	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	_	_	±0.1		±1.0	μA	
Quiescent supply current	ICC	V _{IN} = V _C	_C or GND		5.5	_	_	8.0	_	80.0	μΑ

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition		Ta = 25°C	Ta = −40 to 85°C	Unit
			$V_{CC}(V)$	Limit	Limit	
Minimum pulse width	t _{w (H)}		3.3 ± 0.3	7.0	7.0	20
(CK)	t _{w (L)}	—	5.0 ± 0.5	5.0	5.0	ns
Minimum set-up time	+	_	3.3 ± 0.3	9.0	9.0	20
Minimum set-up time	ts		5.0 ± 0.5	4.5	4.5	ns
Minimum hold time	+ .	_	3.3 ± 0.3	1.0	1.0	20
	t _h		5.0 ± 0.5	1.0	1.0	ns

AC Characteristics (C_L = 50 pF, R_L = 500 Ω , input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
	-,		V _{CC} (V)	Min	Тур.	Max	Min	Max	
Propagation delay time	t _{pLH}	_	3.3 ± 0.3	_	9.8	16.7	1.0	19.0	ns
(CK-Q)	t _{pHL}		5.0 ± 0.5	—	6.1	9.2	1.0	10.5	
Output enable time	t _{pZL}		3.3 ± 0.3		9.2	15.8	1.0	18.0	ns
	t _{pZH}		5.0 ± 0.5	—	6.1	9.3	1.0	10.6	115
Output disable time	t _{pLZ}	_	3.3 ± 0.3	_	6.6	11.0	1.0	12.5	ns
	t _{pHZ}		5.0 ± 0.5	—	5.8	8.8	1.0	10.0	
Maximum clock	f	-	3.3 ± 0.3	50	100	—	50	—	MHz
frequency	f _{max}		5.0 ± 0.5	95	160	—	95	—	IVILITZ
Input capacitance	C _{IN}	_			5	10	_	10	pF
Output capacitance	C _{OUT}	_		_	10	_	_	—	pF
Power dissipation capacitance	C _{PD}		(Note)	_	36	_	_	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per F/F)$

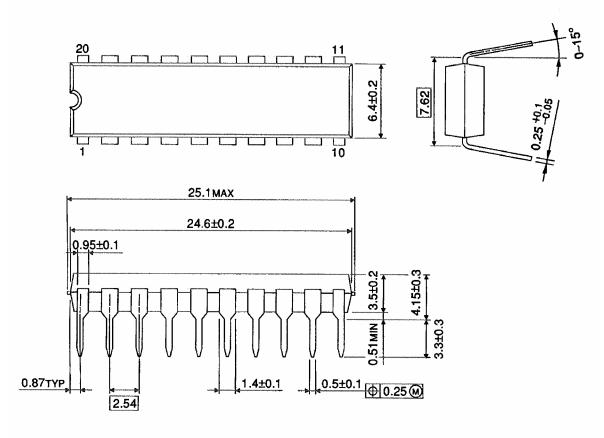
And the total CPD when n pcs. of latch operate can be gained by the following equation:

C_{PD} (total) = 26 + 10·n

Package Dimensions

DIP20-P-300-2.54A

Unit : mm



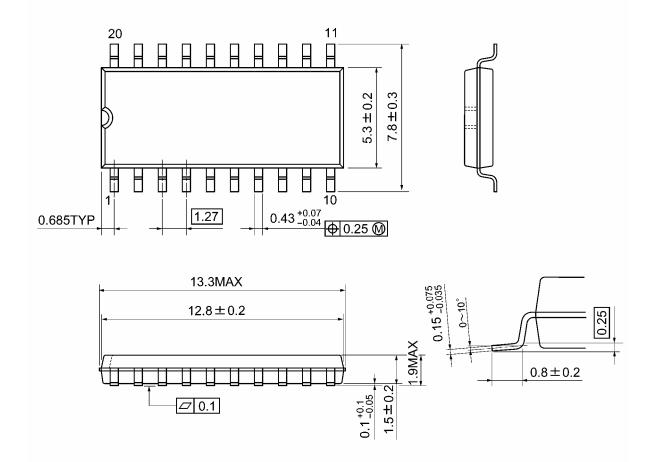
Weight: 1.30 g (typ.)

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Package Dimensions

SOP20-P-300-1.27A

Unit: mm



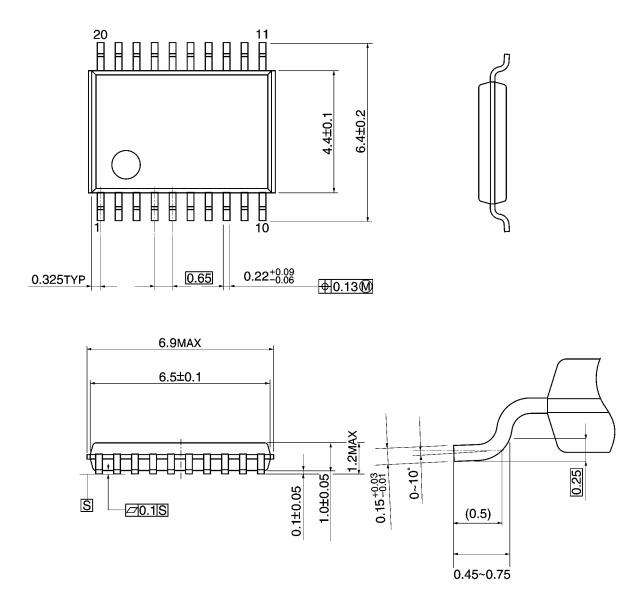
Weight: 0.22 g (typ.)

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Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm



Weight: 0.08 g (typ.)

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20070701-EN GENERAL

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